

# Global Automotive Packaging Market 2023 by Company, Regions, Type and Application, Forecast to 2029

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# **Abstracts**

According to our (Global Info Research) latest study, the global Automotive Packaging market size was valued at USD 8674 million in 2022 and is forecast to a readjusted size of USD 15150 million by 2029 with a CAGR of 8.3% during review period.

Automotive electronics encompasses a variety of products – from body electronics and access systems to engine, lighting and infotainment components. This report studies the Automotive Semiconductor Packaging.

Currently the key players of Automotive OSAT are Amkor, ASE Group and UTAC, Others Automotive OSAT players are mainly located in China Taiwan, South Korea, China mainland, Southeast Asia (Singapore and Malaysia), including Chipbond Technology Corporation, ChipMOS TECHNOLOGIES, Powertech Technology Inc. (PTI), King Yuan Electronics Corp. (KYEC), OSE CORP., Sigurd Microelectronics, Natronix Semiconductor Technology, Nepes, SFA Semicon, Unisem Group, Carsem, Union Semiconductor?Hefei?Co., Ltd., Tongfu Microelectronics (TFME), Hefei Chipmore Technology Co.,Ltd., JCET Group and HT-tech, etc.

The Global Info Research report includes an overview of the development of the Automotive Packaging industry chain, the market status of Automotive OSAT (Advanced Packaging for Automotive, Traditional Packaging for Automotive), Automotive IDM (Advanced Packaging for Automotive, Traditional Packaging for Automotive), and key enterprises in developed and developing market, and analysed the cutting-edge technology, patent, hot applications and market trends of Automotive Packaging.



Regionally, the report analyzes the Automotive Packaging markets in key regions. North America and Europe are experiencing steady growth, driven by government initiatives and increasing consumer awareness. Asia-Pacific, particularly China, leads the global Automotive Packaging market, with robust domestic demand, supportive policies, and a strong manufacturing base.

### Key Features:

The report presents comprehensive understanding of the Automotive Packaging market. It provides a holistic view of the industry, as well as detailed insights into individual components and stakeholders. The report analysis market dynamics, trends, challenges, and opportunities within the Automotive Packaging industry.

The report involves analyzing the market at a macro level:

Market Sizing and Segmentation: Report collect data on the overall market size, including the revenue generated, and market share of different by Type (e.g., Advanced Packaging for Automotive, Traditional Packaging for Automotive).

Industry Analysis: Report analyse the broader industry trends, such as government policies and regulations, technological advancements, consumer preferences, and market dynamics. This analysis helps in understanding the key drivers and challenges influencing the Automotive Packaging market.

Regional Analysis: The report involves examining the Automotive Packaging market at a regional or national level. Report analyses regional factors such as government incentives, infrastructure development, economic conditions, and consumer behaviour to identify variations and opportunities within different markets.

Market Projections: Report covers the gathered data and analysis to make future projections and forecasts for the Automotive Packaging market. This may include estimating market growth rates, predicting market demand, and identifying emerging trends.

The report also involves a more granular approach to Automotive Packaging:

Company Analysis: Report covers individual Automotive Packaging players, suppliers, and other relevant industry players. This analysis includes studying their financial performance, market positioning, product portfolios, partnerships, and strategies.



Consumer Analysis: Report covers data on consumer behaviour, preferences, and attitudes towards Automotive Packaging This may involve surveys, interviews, and analysis of consumer reviews and feedback from different by Application (Automotive OSAT, Automotive IDM).

Technology Analysis: Report covers specific technologies relevant to Automotive Packaging. It assesses the current state, advancements, and potential future developments in Automotive Packaging areas.

Competitive Landscape: By analyzing individual companies, suppliers, and consumers, the report present insights into the competitive landscape of the Automotive Packaging market. This analysis helps understand market share, competitive advantages, and potential areas for differentiation among industry players.

Market Validation: The report involves validating findings and projections through primary research, such as surveys, interviews, and focus groups.

Market Segmentation

Automotive Packaging market is split by Type and by Application. For the period 2018-2029, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of value.

Market segment by Type

Advanced Packaging for Automotive

Traditional Packaging for Automotive

Market segment by Application

Automotive OSAT

Automotive IDM

Market segment by players, this report covers



NXP
Infineon (Cypress)
Renesas
Texas Instrument
STMicroelectronics
Bosch
onsemi
Mitsubishi Electric
Rapidus
Rohm
ADI
Microchip (Microsemi)
Amkor
ASE (SPIL)
UTAC
JCET (STATS ChipPAC)
Carsem
King Yuan Electronics Corp. (KYEC)
KINGPAK Technology Inc
Powertech Technology Inc. (PTI)



SFA Semicon

Unisem Group

**Chipbond Technology Corporation** 

ChipMOS TECHNOLOGIES

OSE CORP.

Sigurd Microelectronics

Natronix Semiconductor Technology

Nepes

**KESM Industries Berhad** 

Forehope Electronic (Ningbo) Co.,Ltd.

Union Semiconductor? Hefei? Co., Ltd.

Tongfu Microelectronics (TFME)

Hefei Chipmore Technology Co.,Ltd.

HT-tech

China Wafer Level CSP Co., Ltd

Ningbo ChipEx Semiconductor Co., Ltd

Guangdong Leadyo IC Testing

Unimos Microelectronics (Shanghai)

Sino Technology



Taiji Semiconductor (Suzhou)

Market segment by regions, regional analysis covers

North America (United States, Canada, and Mexico)

Europe (Germany, France, UK, Russia, Italy, and Rest of Europe)

Asia-Pacific (China, Japan, South Korea, India, Southeast Asia, Australia and Rest of Asia-Pacific)

South America (Brazil, Argentina and Rest of South America)

Middle East & Africa (Turkey, Saudi Arabia, UAE, Rest of Middle East & Africa)

The content of the study subjects, includes a total of 13 chapters:

Chapter 1, to describe Automotive Packaging product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top players of Automotive Packaging, with revenue, gross margin and global market share of Automotive Packaging from 2018 to 2023.

Chapter 3, the Automotive Packaging competitive situation, revenue and global market share of top players are analyzed emphatically by landscape contrast.

Chapter 4 and 5, to segment the market size by Type and application, with consumption value and growth rate by Type, application, from 2018 to 2029.

Chapter 6, 7, 8, 9, and 10, to break the market size data at the country level, with revenue and market share for key countries in the world, from 2018 to 2023.and Automotive Packaging market forecast, by regions, type and application, with consumption value, from 2024 to 2029.

Chapter 11, market dynamics, drivers, restraints, trends and Porters Five Forces analysis.



Chapter 12, the key raw materials and key suppliers, and industry chain of Automotive Packaging.

Chapter 13, to describe Automotive Packaging research findings and conclusion.



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